



Halogens free devices

CHENMKO ENTERPRISE CO.,LTD

SURFACE MOUNT

N-Channel Enhancement Mode Field Effect Transistor

VOLTAGE 400 Volts CURRENT 5 Ampere

CHM730GPAGP

APPLICATION

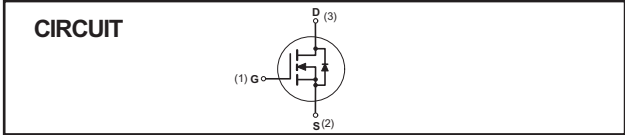
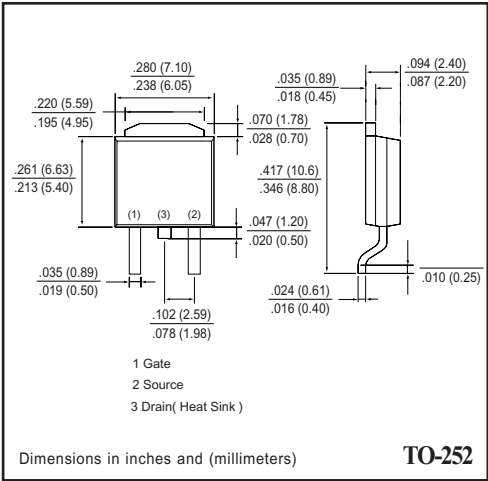
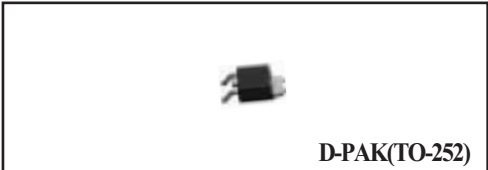
- * Servo motor control.
- * Power MOSFET gate drivers.
- * Other switching applications.

FEATURE

- * Small package. (TO-252)
- * Super high dense cell design for extremely low RDS(ON).

CONSTRUCTION

- * N-Channel Enhancement



Absolute Maximum Ratings $T_A = 25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	CHM730GPAGP	Units
V_{DSS}	Drain-Source Voltage	400	V
V_{GSS}	Gate-Source Voltage	± 30	V
I_D	Maximum Drain Current - Continuous	5	A
	- Pulsed (Note 3)	20	
P_D	Maximum Power Dissipation	68	W
T_J	Operating Temperature Range	-55 to 150	$^\circ\text{C}$
T_{STG}	Storage Temperature Range	-55 to 150	$^\circ\text{C}$

- Note : 1. Surface Mounted on FR4 Board , $t \leq 10\text{sec}$
 2. Pulse Test , Pulse width $\leq 300\mu\text{s}$, Duty Cycle $\leq 2\%$
 3. Repetitive Rating , Pulse width limited by maximum junction temperature
 4. Guaranteed by design , not subject to production trsting

Thermal characteristics

$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient (Note 1)	50	$^\circ\text{C/W}$
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ELECTRICAL CHARACTERISTIC (CHM730GPAGP)

Electrical Characteristics $T_A = 25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Conditions	Min	Typ	Max	Units
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OFF CHARACTERISTICS

BV_{DSS}	Drain-Source Breakdown Voltage	$V_{GS} = 0\text{ V}, I_D = 250\ \mu\text{A}$	400			V
I_{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = 400\text{ V}, V_{GS} = 0\text{ V}$			10	μA
I_{GSSF}	Gate-Body Leakage	$V_{GS} = 30\text{ V}, V_{DS} = 0\text{ V}$			+100	nA
I_{GSSR}	Gate-Body Leakage	$V_{GS} = -30\text{ V}, V_{DS} = 0\text{ V}$			-100	nA

ON CHARACTERISTICS (Note 2)

$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_D = 250\ \mu\text{A}$	2		4	V
$R_{DS(ON)}$	Static Drain-Source On-Resistance	$V_{GS}=10\text{V}, I_D=3\text{A}$		0.8	1.0	Ω
g_{FS}	Forward Transconductance	$V_{DS}=50\text{V}, I_D=5\text{A}$		6		S

Dynamic Characteristics

C_{ISS}	Input Capacitance	$V_{DS} = 25\text{V}, V_{GS} = 0\text{V},$ $f = 1.0\text{ MHz}$		590		pF
C_{OSS}	Output Capacitance			105		
C_{RSS}	Reverse Transfer Capacitance			20		

SWITCHING CHARACTERISTICS (Note 4)

Q_g	Total Gate Charge	$V_{DS}=320\text{V}, I_D=3.5\text{A}$ $V_{GS}=10\text{V}$		14	18	nC
Q_{gs}	Gate-Source Charge			2.5		
Q_{gd}	Gate-Drain Charge			6		
t_{on}	Turn-On Time	$V_{DD}= 200\text{V}$ $I_D = 3.5\text{A}, V_{GS} = 10\text{ V}$ $R_{GEN} = 12\ \Omega$		15	30	nS
t_r	Rise Time			7	14	
t_{off}	Turn-Off Time			30	60	
t_f	Fall Time			5	10	

DRAIN-SOURCE DIODE CHARACTERISTICS AND MAXIMUM RATINGS

I_S	Drain-Source Diode Forward Current	(Note 1)			5	A
V_{SD}	Drain-Source Diode Forward Voltage	$I_S = 3\text{A}, V_{GS} = 0\text{ V}$			1.5	V

RATING CHARACTERISTIC CURVES (CHM730GPAGP)

Typical Electrical Characteristics

Figure 1. Output Characteristics

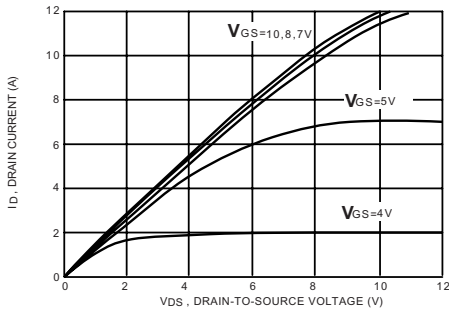


Figure 2. Transfer Characteristics

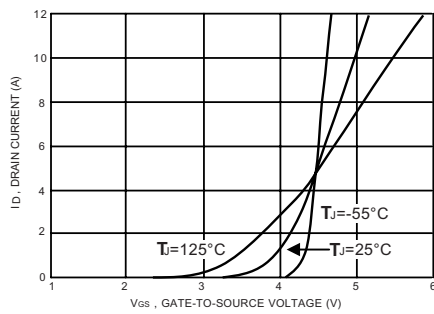


Figure 3. Gate Charge

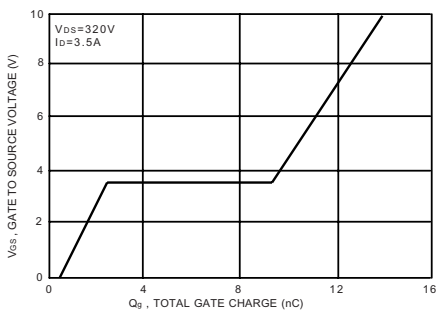


Figure 4. On-Resistance Variation with Temperature

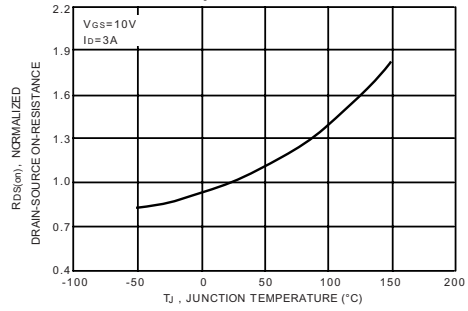


Figure 5. Gate Threshold Variation with Temperature

